

6367254 MOTOROLA SC (XSTRS/R F)

96D 80599

D

T-33-07

MOTOROLA SEMICONDUCTOR TECHNICAL DATA

**BD505
BD507
BD509**

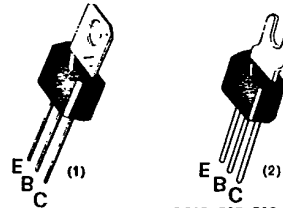
NPN SILICON ANNULAR TRANSISTORS

... designed for complementary symmetry audio circuits

- Excellent Current Gain Linearity — 1.0 mAdc to 1.0 Adc
- Low Collector-Emitter Saturation Voltage — $V_{CE(sat)} = 0.7 \text{ Vdc (Max) @ } I_C = 1.0 \text{ Adc}$
- Complements to PNP BD506, BD508, BD510
- Uniwatt[®] Package for Excellent Thermal Properties —
1.0 Watt @ $T_A = 25^\circ\text{C}$
10.0 Watts @ $T_C = 25^\circ\text{C}$

NPN SILICON AUDIO TRANSISTORS

20 - 30 - 40 VOLTS
10 WATTS



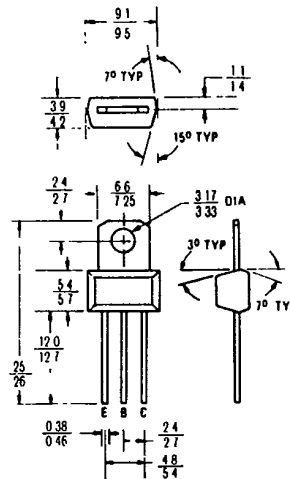
(1) Standard package: BD505, 507, 509
(2) Tab formed for flat mounting: BD505-1, 507-1, 509-1
Also available with leads formed to TO-5 configuration: BD505-5, 507-5, 509-5

MAXIMUM RATINGS

| Rating | Symbol | BD505 | BD507 | BD509 | Unit |
|--|----------------|-------------|-------|-------|----------------------|
| Collector-Emitter Voltage | V_{CEO} | 20 | 30 | 40 | Vdc |
| Collector-Base Voltage | V_{CB} | 30 | 40 | 50 | Vdc |
| Emitter-Base Voltage | V_{EB} | 5.0 | | | Vdc |
| Collector Current - Continuous | I_C | 2.0 | | | Adc |
| Total Device Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C | P_D | 1.0 | | | Watt |
| | | 8.0 | | | mW/ $^\circ\text{C}$ |
| Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C | P_D | 10 | | | Watts |
| | | 80 | | | mW/ $^\circ\text{C}$ |
| Operating and Storage Junction Temperature Range | T_J, T_{stg} | -55 to +150 | | | $^\circ\text{C}$ |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
|---|---------------|------|--------------------|
| Thermal Resistance, Junction to Case | θ_{JC} | 12.5 | $^\circ\text{C/W}$ |
| Thermal Resistance, Junction to Ambient | θ_{JA} | 125 | $^\circ\text{C/W}$ |



All dimensions in millimeters
Collector connected to tab

CASE 152

6367254 MOTOROLA SC (XSTRS/R F)

96D 80600 D

BD505, BD507, BD509

T-33-07

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

| Characteristic | Symbol | Min | Typ | Max | Unit |
|---|-------------------------|------------|----------------|-------------|------|
| OFF CHARACTERISTICS | | | | | |
| Collector-Emitter Breakdown Voltage ($I_C = 1.0 \text{ mA}$, $I_B = 0$) | BD505 BD507 BD509 | BV_{CEO} | 20 30 40 | — — — | Vdc |
| Emitter-Base Breakdown Voltage ($I_E = 100 \mu\text{A}$, $I_C = 0$) | | BV_{EBO} | 5 | — | Vdc |
| Collector Cutoff Current ($V_{CB} = 20, 30, 40 \text{ Vdc}$, $I_E = 0$) | BD505 BD507 BD509 | I_{CBO} | — — — | — — — | nA |

ON CHARACTERISTICS

| | | | | | |
|--|---------------|----------|-----------|--------|-----|
| DC Current Gain (1) ($I_C = 250 \text{ mA}$, $V_{CE} = 2 \text{ Vdc}$) ($I_C = 1.0 \text{ A}$, $V_{CE} = 2 \text{ Vdc}$) | h_{FE} | 60 40 | 160 90 | — — | — |
| Collector-Emitter Saturation Voltage(1) ($I_C = 1.0 \text{ A}$, $I_B = 0.1 \text{ A}$) | $V_{CE(sat)}$ | — | 0.30 | 0.7 | Vdc |
| Base-Emitter On Voltage (1) ($I_C = 1.0 \text{ A}$, $V_{CE} = 1.0 \text{ Vdc}$) | $V_{BE(on)}$ | — | 0.91 | 1.2 | Vdc |

SMALL-SIGNAL CHARACTERISTICS

| | | | | | |
|--|----------|----|-----|----|-----|
| Current-Gain-Bandwidth Product ($I_C = 50 \text{ mA}$, $V_{CE} = 5.0 \text{ Vdc}$, $f = 100 \text{ MHz}$) | f_T | 50 | 250 | — | MHz |
| Output Capacitance ($V_{CB} = 10 \text{ Vdc}$, $I_E = 0$, $f = 100 \text{ kHz}$) | C_{ob} | — | — | 30 | pF |

(1) Pulse Test Pulse Width ~ 300 μs Duty Cycle ~ 20%

FIGURE 1 — DC CURRENT GAIN

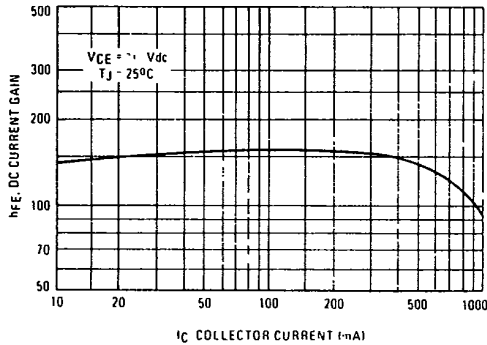


FIGURE 2 — "ON" VOLTAGES

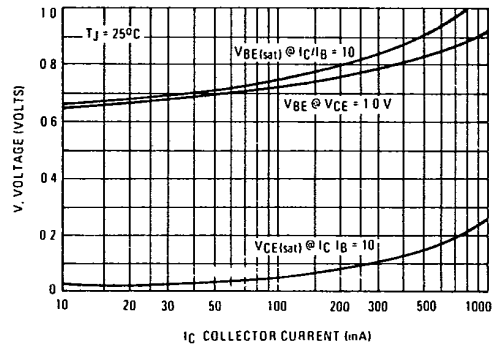
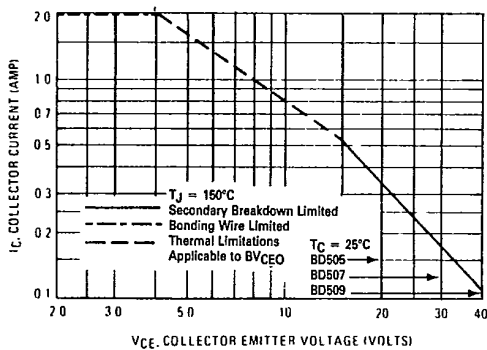


FIGURE 3 — DC SAFE OPERATING AREA



There are two limitations on the power handling ability of a transistor junction temperature and secondary breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation, i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 3 is based on $T_{J(pk)} = 150^\circ\text{C}$. T_C is variable depending on conditions. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by secondary breakdown.